

PATENT ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Tsung-Min Hsieh</td> <td>09/14/2012</td> </tr> <tr> <td>Chien-Hsing Lee</td> <td>09/14/2012</td> </tr> <tr> <td>Jhyy-Cheng Liou</td> <td>09/14/2012</td> </tr> </tbody> </table>		Name	Execution Date	Tsung-Min Hsieh	09/14/2012	Chien-Hsing Lee	09/14/2012	Jhyy-Cheng Liou	09/14/2012		
Name	Execution Date										
Tsung-Min Hsieh	09/14/2012										
Chien-Hsing Lee	09/14/2012										
Jhyy-Cheng Liou	09/14/2012										
RECEIVING PARTY DATA											
<table border="1"> <tr> <td>Name:</td> <td>Solid State System Co., Ltd.</td> </tr> <tr> <td>Street Address:</td> <td>5F-1, No. 22, Taiyuen Street, Jubei City,</td> </tr> <tr> <td>City:</td> <td>Hsinchu</td> </tr> <tr> <td>State/Country:</td> <td>TAIWAN</td> </tr> <tr> <td>Postal Code:</td> <td>302</td> </tr> </table>		Name:	Solid State System Co., Ltd.	Street Address:	5F-1, No. 22, Taiyuen Street, Jubei City,	City:	Hsinchu	State/Country:	TAIWAN	Postal Code:	302
Name:	Solid State System Co., Ltd.										
Street Address:	5F-1, No. 22, Taiyuen Street, Jubei City,										
City:	Hsinchu										
State/Country:	TAIWAN										
Postal Code:	302										
PROPERTY NUMBERS Total: 1											
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>13615645</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	13615645						
Property Type	Number										
Application Number:	13615645										
CORRESPONDENCE DATA											
<p>Fax Number: 5105807280</p> <p><i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i></p> <p>Email: usa@jicpgroup.com.tw</p> <p>Correspondent Name: Jianq Chyun Intellectual Property Office</p> <p>Address Line 1: 7F.-1, NO. 100, ROOSEVELT RD., SEC. 2,</p> <p>Address Line 4: Taipei, TAIWAN 100</p>											
ATTORNEY DOCKET NUMBER:	43164-US-PA										
NAME OF SUBMITTER:	Belinda Lee										
<p>Total Attachments: 2</p> <p>source=43164_assgn#page1.tif</p> <p>source=43164_assgn#page2.tif</p>											

CH \$40.00 13615645

ASSIGNMENT

WHEREAS,

1. Tsung-Min Hsieh
2. Chien-Hsing Lee
3. Jhyy-Cheng Liou

hereinafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: **MICROELECTROMECHANICAL SYSTEM (MEMS) DEVICE AND FABRICATION METHOD THEREOF**

[] Filed: Serial No.

[x] Executed concurrently with the execution of this instrument

WHEREAS, Solid State System Co., Ltd.

of 5F-1, No. 22, Taiyuen Street, Jubei City, Hsinchu, Taiwan 302, R.O.C.

hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

43164-US-PA

ASSIGNMENT CONTINUED

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

Signature: Tsung-Min Hsieh
Sole or First Joint Inventor: Tsung-Min Hsieh

Date: SEP. 14, 2012

Signature: Chien-Hsing Lee
Second Joint Inventor (if any): Chien-Hsing Lee

Date: SEP. 14, 2012

Signature: Jhyy-Cheng Liou
Third Joint Inventor (if any): Jhyy-Cheng Liou

Date: SEP. 14, 2012